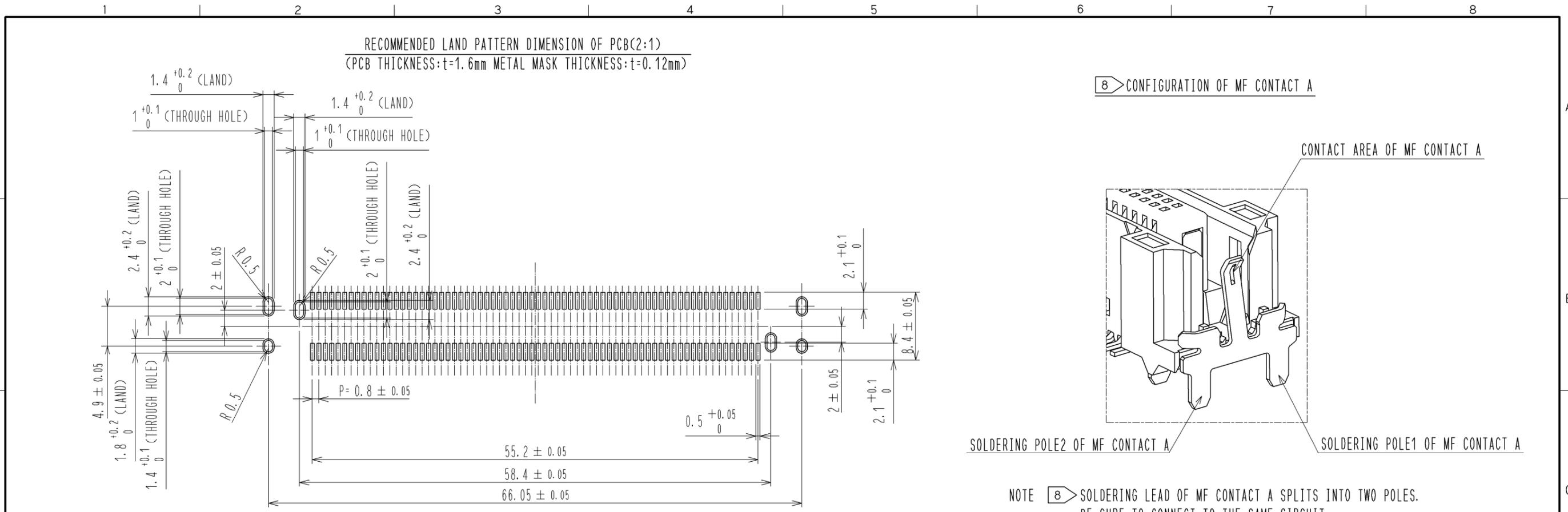


- NOTE 1 LEAD CO-PLANARITY IS 0.1mm MAX.  
 2 CONTACTS ARE 3 STEPS SEQUENTIAL. (MF CONTACT A=>SIGNAL CONTACT=>MF CONTACT B) WHEN USING THIS SEQUENTIAL STRUCTURE, PLEASE AVOID ANGLED INSERTION.  
 3 MF CONTACT A AND MF CONTACT B CAN BE USED AS POWER SUPPLY CONTACT. (3A/PIN MAX)  
 4 IT SHOWS THE VACUUM PICKUP AREA. (SEE PAGE 2) REMOVE THE MYLAR TAPE BEFORE MATING CONNECTORS.  
 5 THIS IS PACKAGED IN TRAY. (40pcs/TRAY)  
 6 BLEMISH AND HIT MARK CAN BE OCCURED THROUGH OUT THE MANUFACTURING PROCESS WHICH DOESN' T AFFECT QUALITY LEVEL.  
 7 THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCES.

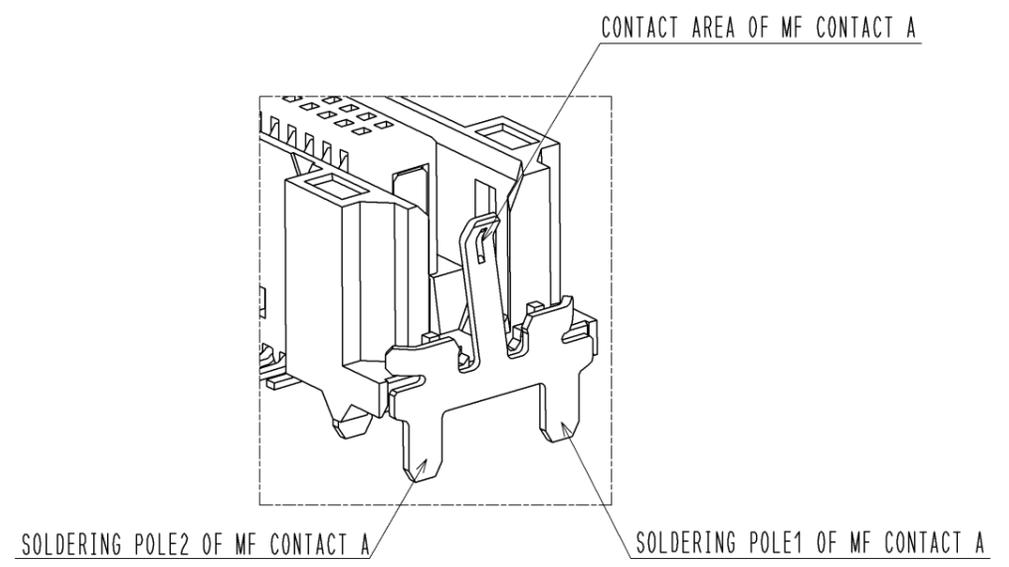
6	POLYIMIDE	
5	POLYSTYRENE	
4	COPPER ALLOY	CONTACT AREA:GOLD 0.1 μm LEAD AREA:TIN-PLATING 1 μm UNDER PLATING:NICKEL 1.3 μm
3	COPPER ALLOY	CONTACT AREA:GOLD 0.1 μm LEAD AREA:TIN-PLATING 1 μm UNDER PLATING:NICKEL 1.3 μm
2	COPPER ALLOY	CONTACT AREA:GOLD 0.1 μm LEAD AREA:GOLD 0.03 μm UNDER PLATING:NICKEL 1.3 μm
1	POLYAMIDE	BLACK UL94V-0

NO.	MATERIAL	FINISH	REMARKS	NO.	MATERIAL	FINISH	REMARKS
6	POLYIMIDE			6	POLYIMIDE		
5	POLYSTYRENE			5	POLYSTYRENE		
4	COPPER ALLOY			4	COPPER ALLOY		
3	COPPER ALLOY			3	COPPER ALLOY		
2	COPPER ALLOY			2	COPPER ALLOY		
1	POLYAMIDE			1	POLYAMIDE		

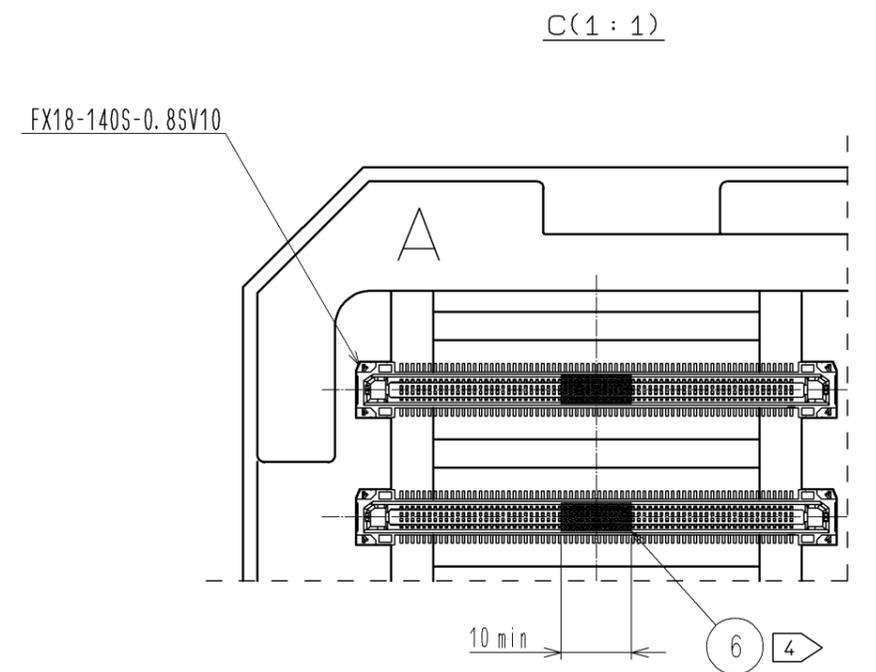
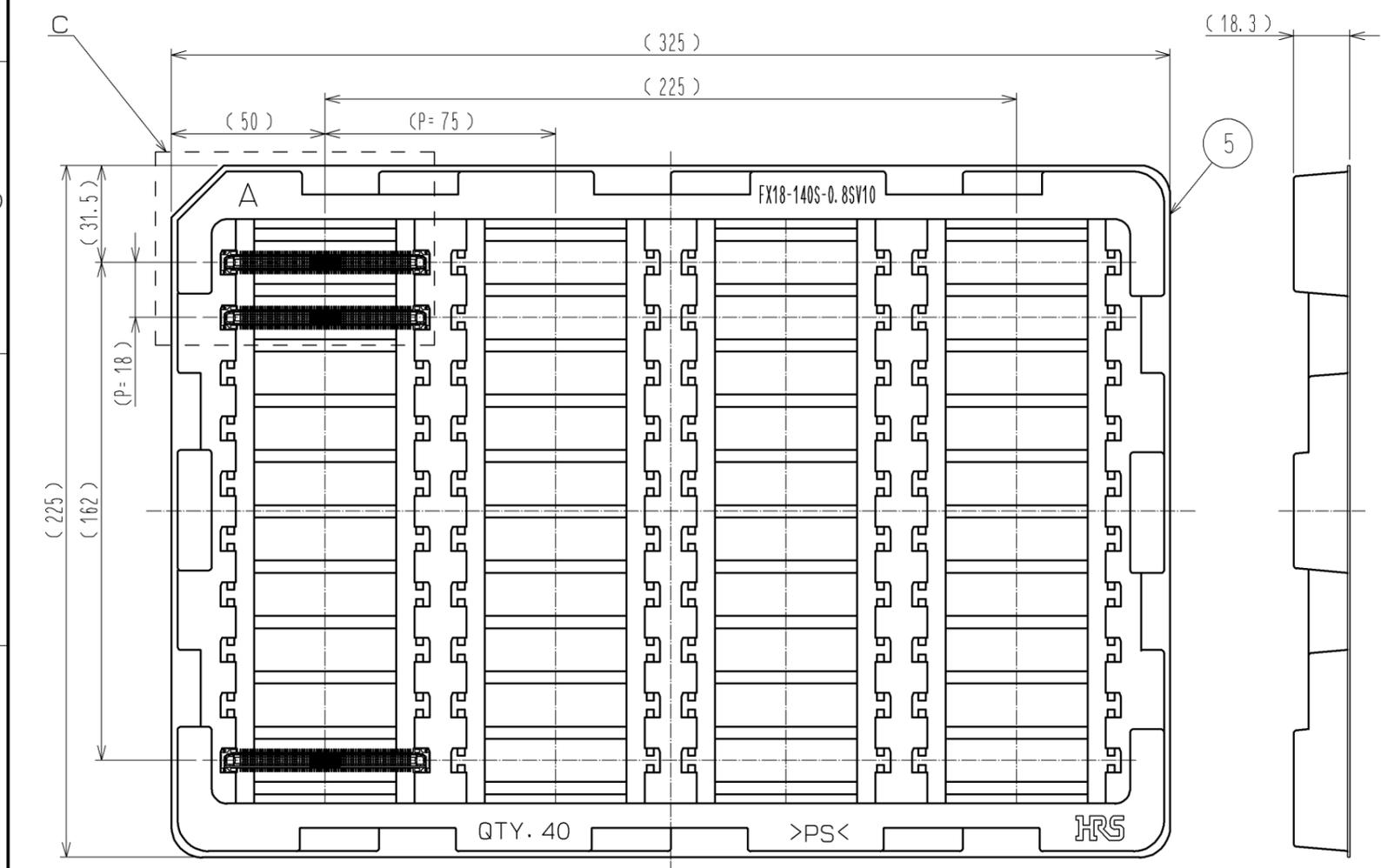
UNITS	mm	SCALE	2 : 1	COUNT	△	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
APPROVED : HS. OKAWA		13.03.27		DRAWING NO.		EDC3-349392-00			
CHECKED : KI. HIROKAWA		13.03.27		PART NO.		FX18-140S-0.8SV10			
DESIGNED : TH. SANO		13.03.27		CODE NO.		CL579-0060-1-00			
DRAWN : TH. SANO		13.03.27							



8 CONFIGURATION OF MF CONTACT A



NOTE 8 SOLDERING LEAD OF MF CONTACT A SPLITS INTO TWO POLES. BE SURE TO CONNECT TO THE SAME CIRCUIT.



<b>HRS</b>	DRAWING NO.	EDC3-349392-00
	PART NO.	FX18-140S-0.8SV10
	CODE NO.	CL579-0060-1-00
		△ 2/2